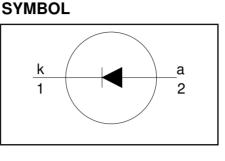
# Rectifier diodes fast, soft-recovery

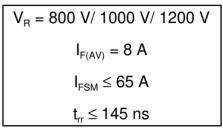
### BY329F, BY329X series

### FEATURES

- Low forward volt drop
- · Fast switching
- Soft recovery characteristic
- High thermal cycling performance
- Isolated mounting tab



### QUICK REFERENCE DATA



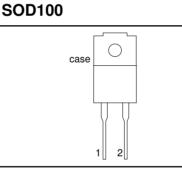
### **GENERAL DESCRIPTION**

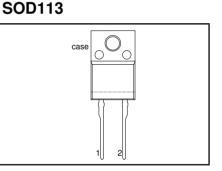
Glass-passivated double diffused rectifier diodes featuring low forward voltage drop, fast reverse recovery and soft recovery characteristic. The devices are intended for use in TV receivers, monitors and switched mode power supplies.

The BY329F series is supplied in the conventional leaded SOD100 package. The BY329X series is supplied in the conventional leaded SOD113 package.

#### PINNING

# PINDESCRIPTION1cathode2anodetabisolated





### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.			UNIT
V <sub>RSM</sub>	Peak non-repetitive reverse voltage	BY329F / BY329X	-	<b>-800</b> 800	<b>-1000</b> 1000	<b>-1200</b> 1200	V
V <sub>RRM</sub> V <sub>RWM</sub>	Peak repetitive reverse voltage Crest working reverse voltage		-	800 600	1000 800	1200 1000	V V
I <sub>F(AV)</sub>	Average forward current <sup>1</sup>	square wave; $\delta = 0.5$ ; T <sub>hs</sub> $\leq 83$ °C sinusoidal; a = 1.57;	-		8		A A
F(RMS)	RMS forward current	$T_{hs} \le 90 \degree C$	-		7 11 16		A A A
I <sub>FRM</sub> I <sub>FSM</sub>	Peak repetitive forward current Peak non-repetitive forward	t = 25 $\mu$ s; $\delta$ = 0.5; T <sub>hs</sub> ≤ 83 °C t = 10 ms	-		65		А
	current.	t = 8.3 ms sinusoidal; T <sub>i</sub> = 150 °C prior to surge; with reapplied	-		71		A
$\begin{matrix} I^2 t \\ T_{stg} \\ T_j \end{matrix}$	l <sup>2</sup> t for fusing Storage temperature Operating junction temperature	$V_{\text{RWM}(\text{max})}$ t = 10 ms	-40 -		28 150 150		A²s °C °C

1. Neglecting switching and reverse current losses.

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### **ISOLATION LIMITING VALUE & CHARACTERISTIC**

 $T_{hs} = 25$  °C unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>isol</sub>	Peak isolation voltage from both terminals to external heatsink	SOD100 package; R.H. $\leq$ 65%; clean and dustfree	-	-	1500	V
V <sub>isol</sub>	R.M.S. isolation voltage from both terminals to external heatsink	SOD113 package; f = 50-60 Hz; sinusoidal waveform; R.H. $\leq$ 65%; clean and dustfree	-	-	2500	V
C <sub>isol</sub>	Capacitance from pin 1 to external heatsink	f = 1 MHz	-	10	-	рF

#### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
R <sub>th j-hs</sub> R <sub>th j-a</sub>	heatsink	with heatsink compound without heatsink compound in free air.	-	- - 55	4.8 5.9 -	K/W K/W K/W

### STATIC CHARACTERISTICS

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>F</sub>	Forward voltage	I <sub>F</sub> = 20 A	-	1.5	1.85	V
I <sub>R</sub>	Reverse current	V <sub>R</sub> = V <sub>RWM</sub> ; T <sub>j</sub> = 125 °C		0.1	1.0	mA

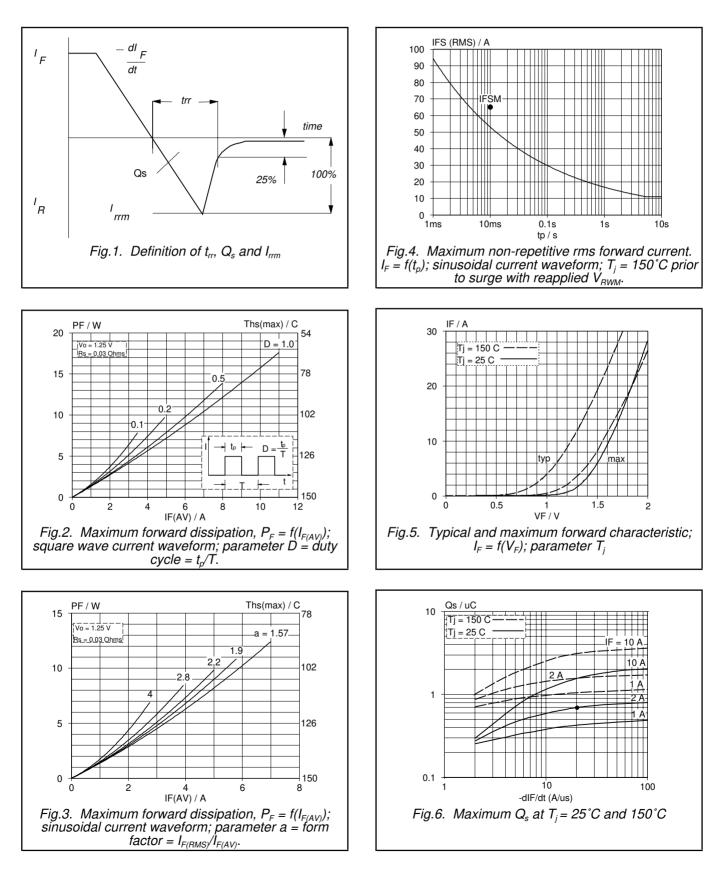
### **DYNAMIC CHARACTERISTICS**

 $T_i = 25$  °C unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
t <sub>rr</sub> Q <sub>s</sub> dI <sub>R</sub> /dt	Reverse recovery time Reverse recovery charge Maximum slope of the reverse recovery current	$ \begin{array}{l} I_{F}=1 \ A; \ V_{R} \geq 30 \ V; \ \text{-}dI_{F}/dt = 50 \ A/\mu s \\ I_{F}=2 \ A; \ V_{R} \geq 30 \ V; \ \text{-}dI_{F}/dt = 20 \ A/\mu s \\ I_{F}=2 \ A; \ \text{-}dI_{F}/dt = 20 \ A/\mu s \end{array} $	- - -	125 0.5 50	145 0.7 60	ns μC A/μs

BY329F, BY329X series

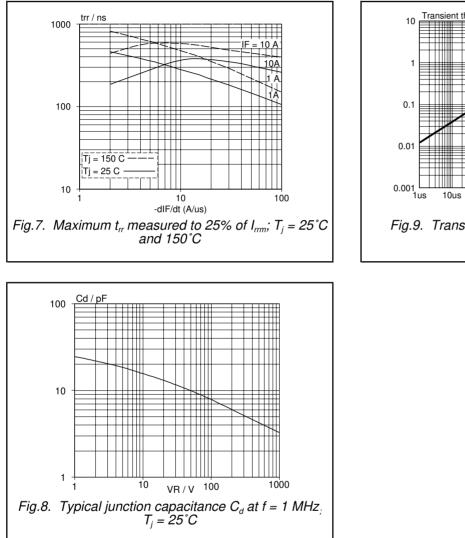
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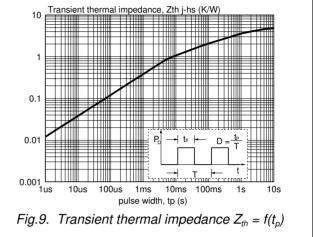


Product specification

# Rectifier diodes fast, soft-recovery

### BY329F, BY329X series

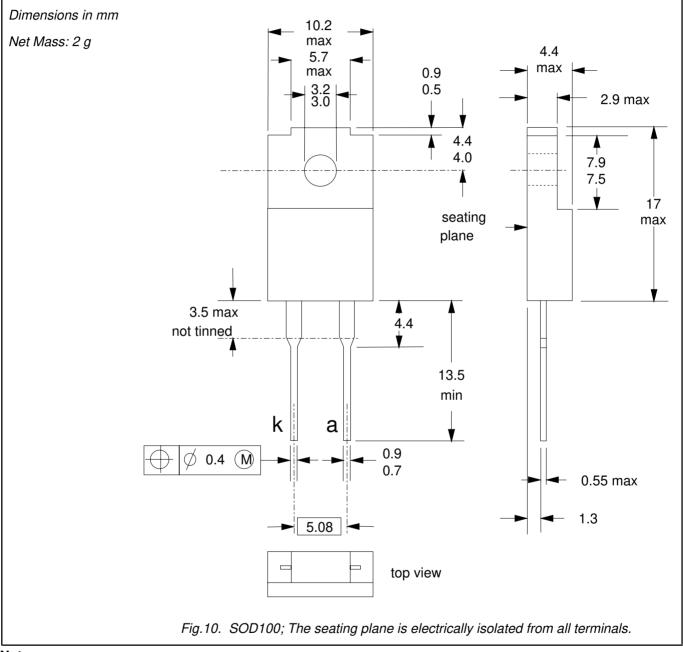




### **Rectifier diodes** fast, soft-recovery

### BY329F, BY329X series

### **MECHANICAL DATA**



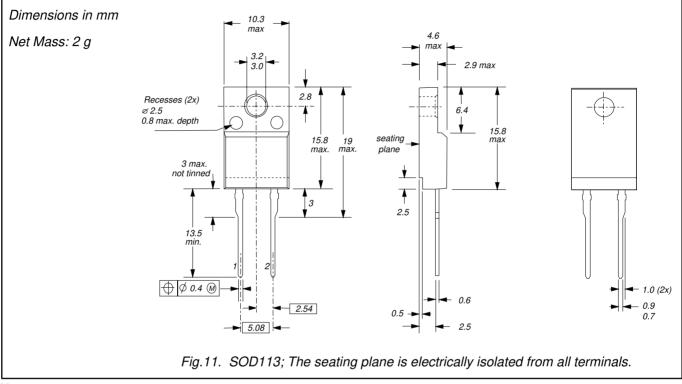


Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

### **Rectifier diodes** fast, soft-recovery

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### **MECHANICAL DATA**



#### Notes

Refer to mounting instructions for F-pack envelopes.
Epoxy meets UL94 V0 at 1/8".

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#### DEFINITIONS

Data sheet status						
Objective specification	Objective specification This data sheet contains target or goal specifications for product development.					
Preliminary specification	specification This data sheet contains preliminary data; supplementary data may be published later.					
Product specification	This data sheet contains final product specifications.					
Limiting values						
or more of the limiting val operation of the device at	Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.					
Application information						
Where application information is given, it is advisory and does not form part of the specification.						
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